

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
250V	80mΩ@10V	40A

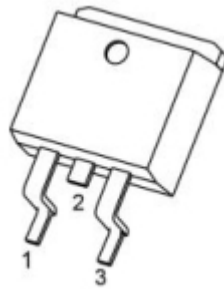
Feature

- Fast Switching
- Low Gate Charge and Rdson
- 100% Single Pulse avalanche energy Test

Application

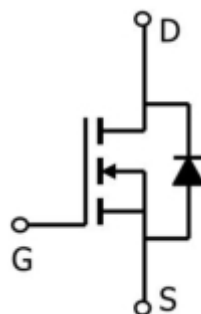
- Power switching application
- DC-DC Converter
- Power Management

Package

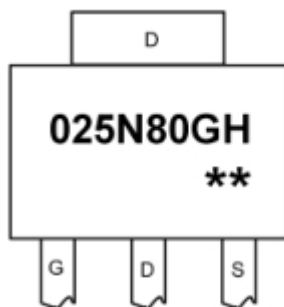


TO-263(1:G 2:D 3:S)

Circuit diagram



Marking



025N80GH : Product code
****** : Week code

Absolute maximum ratings

(T_a=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain source voltage	V _{DS}	250	V
Gate source voltage	V _{GS}	±20	V
Continuous drain current(Tc=25°C)	I _D	40	A
Pulsed drain current	I _{DM}	160	A
Power dissipation(Tc=25°C)	P _D	357	W
Single pulsed avalanche energy ¹⁾	E _{AS}	972	mJ
Thermal resistance, junction-case	R _{θJC}	0.35	°C/W
Operation and storage temperature	T _J	-55 to 150	°C

Electrical characteristics

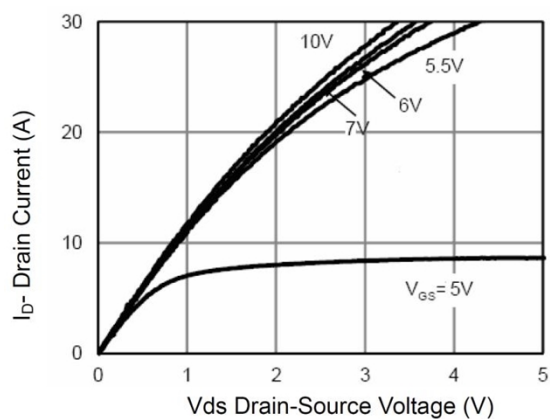
(T_A=25°C, unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-source breakdown voltage	$BV_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	250			V
Drain Cut-Off Current	I_{DSS}	$V_{DS} = 200V, V_{GS} = 0V$			1	μA
Gate-body leakage current	I_{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$			± 0.1	μA
Gate-source threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	2	3	4	V
Drain-source on-resistance	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 20A$		80	100	m Ω
Dynamic Characteristics						
Input Capacitance	C_{iss}	$V_{DS} = 25V, V_{GS} = 0V,$ $f = 1MHz$		2880		pF
Output Capacitance	C_{oss}			403		
Reverse Transfer Capacitance	C_{rss}			35		
Switching Characteristics						
Total Gate Charge	Q_g	$V_{DS} = 200V, V_{DS} = 10V,$ $I_D = 45A$		55		pF
Gate-Source Charge	Q_{gs}			17		
Gate-Drain Charge	Q_{gd}			26		
Turn-On Delay Time	$T_{d(on)}$	$V_{GS} = 10V, V_{DS} = 125V,$ $I_D = 45A, R_G = 10\Omega$		33		nS
Rise Time	T_r			151		
Turn-Off Delay Time	$T_{d(off)}$			61		
Fall Time	T_f			89		
Drain-Source Body Diode Characteristics						
Source-Drain Diode Forward Voltage	V_{SD}	$V_{GS} = 0V, I_S = 1A$			1.2	V

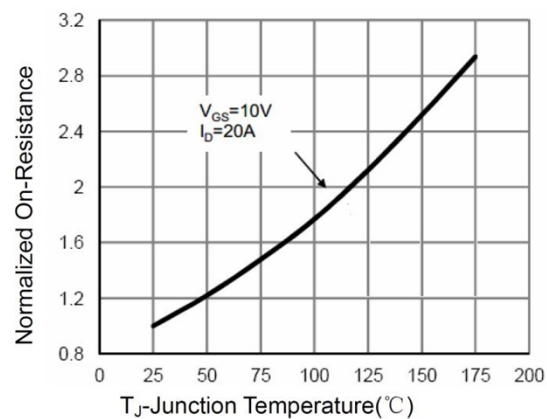
Note:

1. E_{AS} is tested at starting T_j = 25°C, V_{DD} = 75V, V_{GS} = 10V, L = 0.5mH, R_G = 25mΩ;

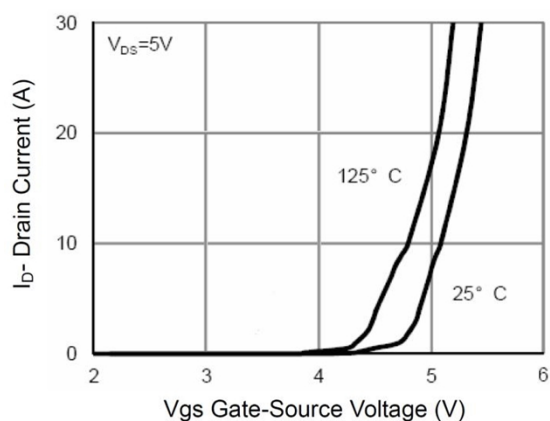
Typical Characteristics



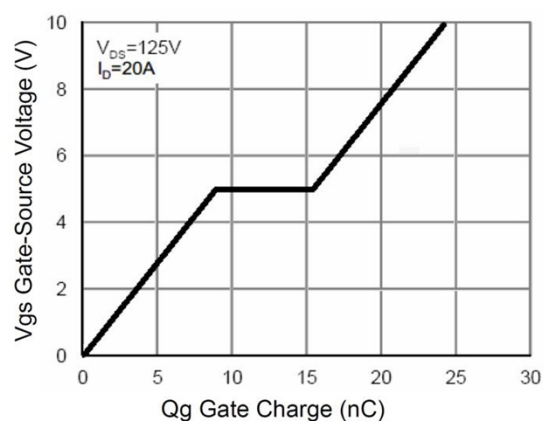
Output Characteristics



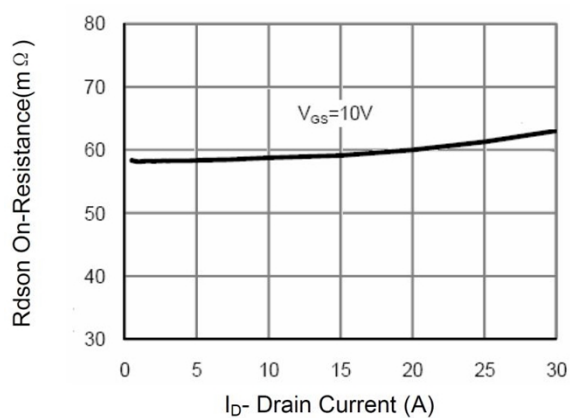
$R_{DS(on)}$ -Junction Temperature



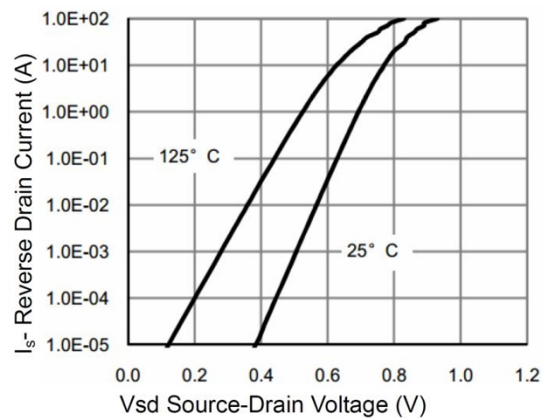
Transfer Characteristics



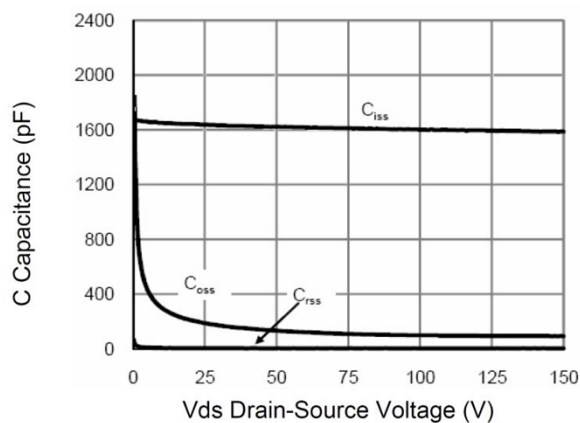
Gate Charge



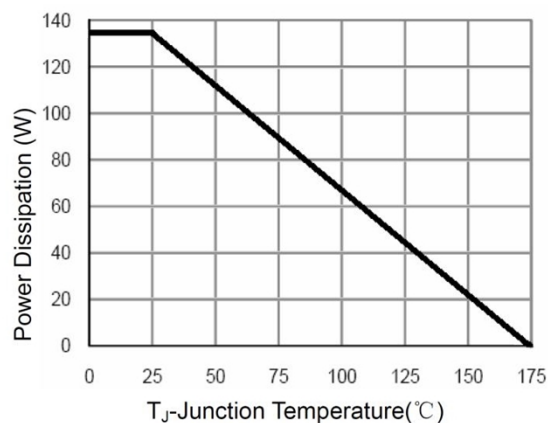
$R_{DS(on)}$ - Drain Current



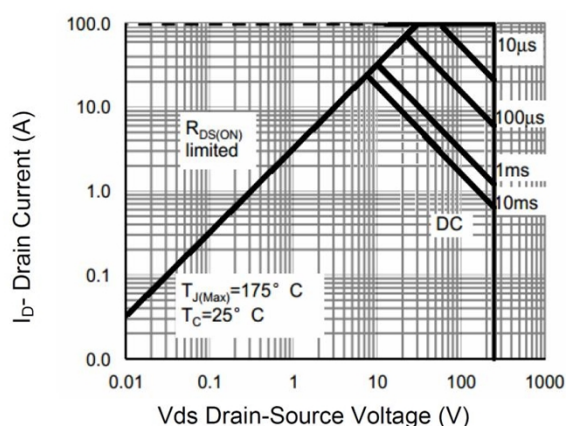
Source- Drain Diode Forward



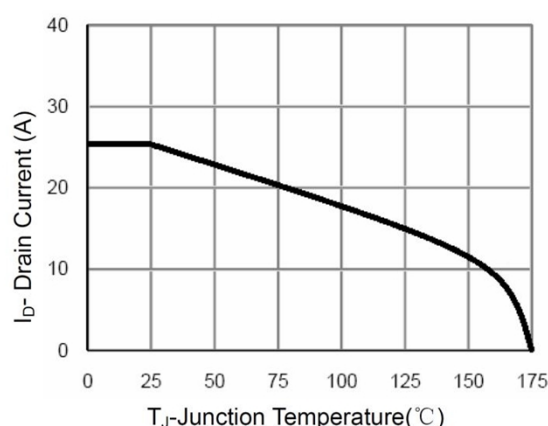
Capacitance vs Vds



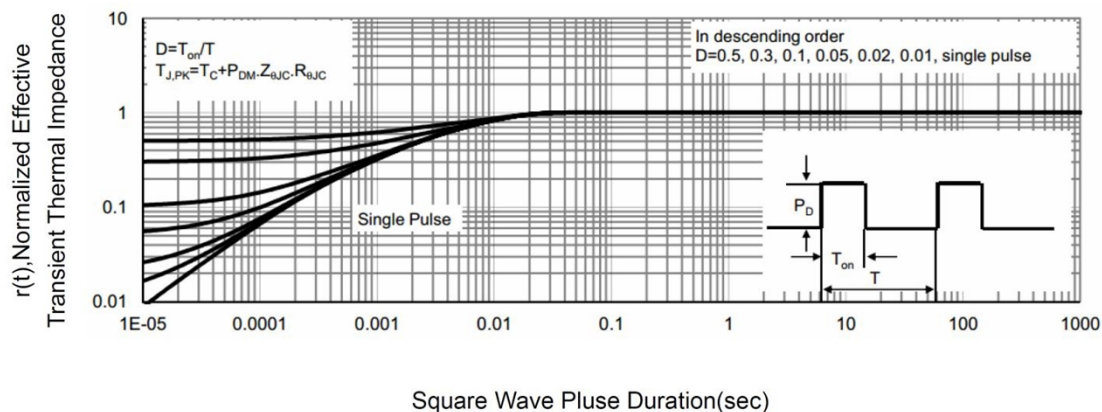
Power De-rating



Safe Operation Area

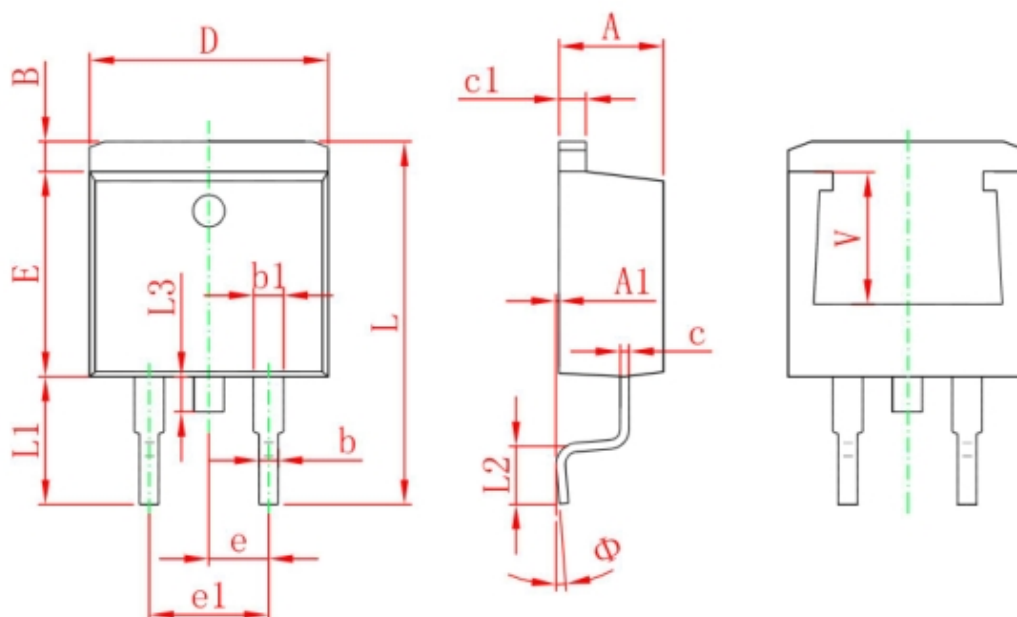


Current De-rating



Normalized Maximum Transient Thermal Impedance

TO-263 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.470	4.670	0.176	0.184
A1	0.000	0.150	0.000	0.006
B	1.120	1.420	0.044	0.056
b	0.710	0.910	0.028	0.036
b1	1.170	1.370	0.046	0.054
c	0.310	0.530	0.012	0.021
c1	1.170	1.370	0.046	0.054
D	10.010	10.310	0.394	0.406
E	8.500	8.900	0.335	0.350
e	2.540 TYP.		0.100 TYP.	
e1	4.980	5.180	0.196	0.204
L	14.940	15.500	0.588	0.610
L1	4.950	5.450	0.195	0.215
L2	2.340	2.740	0.092	0.108
L3	1.300	1.700	0.051	0.067
Φ	0°	8°	0°	8°
V	5.600 REF.		0.220 REF.	